



SPECIFICATION FOR APPROVAL

CUSTOMER			
NOMINAL FREQUENCY	16.000000 MHz		
PRODUCT TYPE	TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL		
SPEC. NO. (P/N)	FL1600011		
CUSTOMER P/N			
ISSUE DATE	January 3, 2018		
VERSION	E		

APPROVED	PREPARED	QA
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Diodes Incorporated

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- *Pb-free
- *RoHS Compliant
- *HF-Halogen Free
- *REACH Compliant

E0-R-4-014 Rev. F

FL1600011 VER. E 3-Jan-18

VERSION HISTORY

Version No.	Version Date	Description	Notes
А	Jul.8,2008	Initial Release	
В	Nov.5,2010	Changed ESR from 100Ω to 80Ω & Temp. range from $-20 \sim 70$ °C to $-40 \sim 85$ °C & Marking from eCERA to SRe.	
С	Nov.14,2012	Updated Suggested IR Reflow Profile & Format	
D	Feb.7,2013	Changed ESR from 80Ω to 60Ω .	
E	Jan.3,2018	Updated logo	

FL1600011 VER. E

3-Jan-18

ELECTRICAL SPECIFICATIONS

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	16.000000	MHz	
Mode of Oscillation	МО	AT Cut-Fundamental		
Calibration Load Capacitance	CL	9	pF	
Calibration Tolerance	FL	±20	ppm	at 25℃±3℃
Operating Temperature Range	TR	-40 to +85	C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±20	ppm	Reference to the Frequency at 25℃
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	60	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25℃		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	C	
Insulation Resistance		500	ΜΩ	Min
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※ This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



FL1600011

VER. E 3-Jan-18

RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

a) FINE LEAK TEST: JESD22-A109 (Condition 1A)

b) GROSS LEAK TEST: JESD22-A109 (Condition C)

c) MOISTURE RESISTANCE: JESD22-A113

d) SHOCK: JESD22-B104 (Condition B)

e) SOLDERABILITY: (RoHS version): J-STD-002

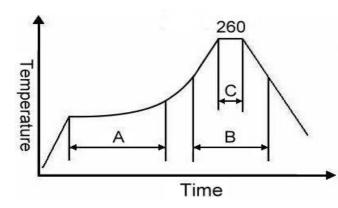
f) VIBRATION: JESD22-B103

g) SOLVENT RESISTANCE: JESD22-B107

h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



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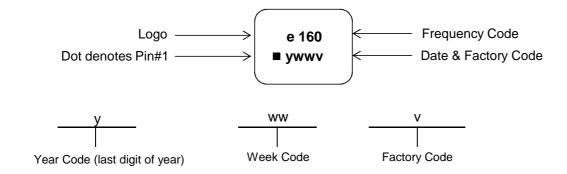
	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec

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FL1600011

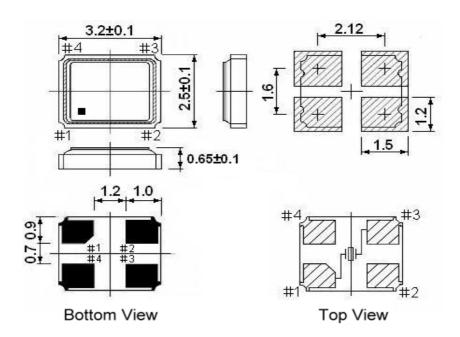
VER. E 3-Jan-18

MARKING



MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)

Recommended Land Pattern



** Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

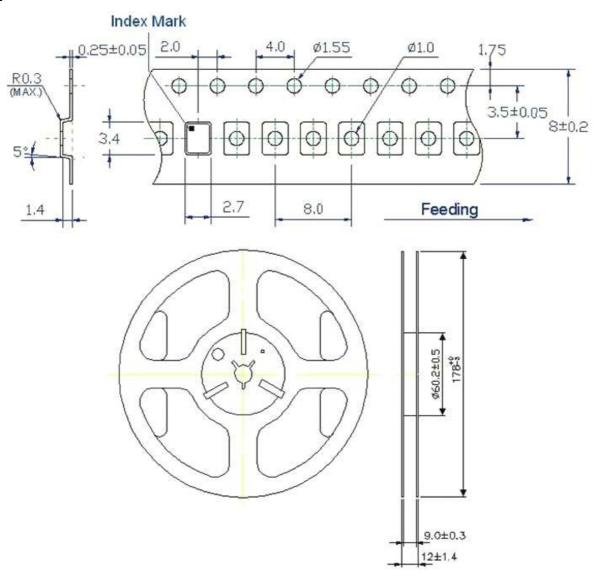
Notes:

- Package drawings are for reference only, and the appearances of objects may vary.
 Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.

DES INCORPORATED

VER. E 3-Jan-18

Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

